Overview

HP Z820 Workstation



- 1. 3 External 5.25" Bays
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a

Overview



- 5. Choice of 850W, 88% or 1125W, 90% Efficient Power Supplies
- 6. 16 DIMM Slots for DDR3 ECC Memory
- 7. 3 External 5.25" Bays
- 8. 4 Internal 3.5" Bays
- 9. 2 Intel Xeon Processors E5-2600 family

- 10. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 4 USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone, 1 Serial Port
- 11. 3 PCIe x16 Gen3 Slots (3rd Slot available ONLY when 2nd CPU is installed)
- 12. 1 PCIe x16 (x8) Gen3 (Available ONLY when 2nd CPU is installed), 1 PCIe x8(x4) Gen3, 1 PCIe x8(x4) Gen2, 1 PCI Slot
- 13. 6 Internal USB 2.0 Ports
- 14. 6 SATA, 8 SAS Ports

Form Factor	Rackable Minitower
Operating Systems	Preinstalled:
	 Windows 7 Professional 32-bit* Windows 7 Professional 64-bit* Windows 8.1 Pro MSNA 64 to Win7 Professional 32-bit Windows 8.1 Pro MSNA 64 to Win7 Professional 64-bit Windows 8.1 Pro 64 downgrade to Win7 Professional 32-bit Windows 8.1 Pro 64 downgrade to Win7 Professional 64-bit Windows 8.1 Pro 64-bit OS



Overview

- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)
- Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)
- Genuine Windows® 7 Enterprise 32/64
- SUSE Linux Enterprise Desktop 11
- Windows® XP Professional 32/64 (on select configurations)*

Notes: *See the "Windows XP Support Matrix for Z Workstations" at:

http://www.hp.com/support/workstation_manuals

Notes: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux_hardware_matrix

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology¹	TDP (W)
Intel Xeon E5-2643 processor	4	3.3	10	1600	8.0	Y	Y	1, 2	130
Intel Xeon E5-2620 processor	6	2.0	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2697 v2 processor	12	2.7	30	1866	8.0	Y	Y	3, 8	130
Intel Xeon E5-2695 v2 processor	12	2.4	30	1866	8.0	Υ	Y	4, 8	115
Intel Xeon E5-2690 v2 processor	10	3.0	25	1866	8.0	Y	Y	3, 6	130
Intel Xeon E5-2687W v2 processor	8	3.4	20	1866	8.0	Υ	Y	2, 6	150
Intel Xeon E5-2680 v2 processor	10	2.8	25	1866	8.0	Y	Y	3, 8	115
Intel Xeon E5-2670 v2 processor	10	2.5	25	1866	8.0	Y	Y	4, 8	115
Intel Xeon E5-2667 v2 processor	8	3.3	25	1866	8.0	Y	Y	3, 7	130
Intel Xeon E5-2660 v2 processor	10	2.2	25	1866	8.0	Y	Y	4, 8	95
Intel Xeon E5-2650 v2 processor	8	2.6	20	1866	8.0	Y	Y	4, 8	95
Intel Xeon E5-2643 v2 processor	6	3.5	25	1866	8.0	Y	Y	1, 3	130
Intel Xeon E5-2640 v2 processor	8	2.0	20	1600	7.2	Y	Y	3, 5	95
Intel Xeon E5-2637 v2 processor	4	3.5	15	1866	8.0	Y	Y	1, 3	130
Intel Xeon E5-2630 v2 processor	6	2.6	15	1600	7.2	Y	Y	3, 5	80
Intel Xeon E5-2620 v2 processor	6	2.1	15	1600	7.2	Y	Y	3, 5	80
Intel Xeon	4	2.5	10	1333	6.4	N	Υ	N/A	80



Overview

E5-2609 v2 processor									
Intel Xeon E5-2603 v2 processor	4	1.8	10	1333	6.4	N	Υ	N/A	80
	cor	e maxim t have tur		s). Turbo boo ty are denote	st stepping d as N/A.	occurs in 100	OMHz increme	aximum turbo ste ents. Processors t	
Available Processor Disclaimers	Qu per and to the will htt	mbers are thin each p://www ad-Core, formanced may reconstruction to the comperating system operate l vary depp://www el® Xeon®	e not a measur processor fam intel.com/processor fam intel.com/processor Eduire appropriate suitability; Nologies. Duting on Intelestem, device of (including 32-pending on you intel.com/info	tement of hig illy, not acros ducts/proces t-Core, Ten-Caded software ate operating ot all custom 64 architect drivers, and a bit operation ur hardware a o/em64t for no -2687W is ON	her performs different sor number of	nance. Proces processor far er/ for details velve-Core te and hardware ftware for full ware application es a computer e enabled for I in Intel® 64 are e configuration hation. le with Liquid	ssor numbers milies. See: chnologies are e-aware multile benefits; che ions will neces system with a ntel® 64 archichitecture-enons. See: Cooling AND	e designed to implicate feating operating tasking operating sck with software ssarily benefit from a processor, chiplitecture. Processor abled BIOS. Performation with the 1125W F	orove g systems provider om use of set, BIOS ors will ormance
Form Factor		-2697 V2 ckable Mi	REQUIRE the 1	125W Power	Supply Up	tion.			
Color		ckable Mi ck/Silver							
I/O Slots (see system board section for more details)		 2 P 1 P 1 P 1 P 1 P 1 M mo 	CI Express Gen CI Express Gen CI Express Gen CI Express Gen CI Express Gen CI 32bit/33MH lechanical-only therboard (hal	13 x16 slot - <i>F</i> 13 x8 slot - wi 13 x4 slot - wi 12 x4 slot - wi z slot y slot, suppoi 1f-length, full	th x16 con th x8 conn th x8 conn ting cards -height)	nector Avai ector ector which mount	lable ONLY wh	led. hen 2nd CPU is ins O bulkhead and n be seated in the s	ot the
Bays (see storage section for more details)	on To	tal Bays =	= 7						
Internal Bays	4 ir	nternal 3.	.5" bays (4 with	n acoustic dar	npening ra	il assemblies)			
External Bays	To _l Mid	p bay dev Idle bay (.25" bays vice depth limit device depth liv device depth l	mit: 206mm					
Front I/O			USB 2.0, 1 Hea		icrophone,	and 1 IEEE 13	394a		
Rear I/O	1 II 2 U	EEE 1394 ISB 3.0 ISB 2.0		,	,,				



Overview

	1 Serial						
	PS/2 keyboard and mouse 2 RJ-45 to integrated Gigabit LAN						
	1 Audio Line-In, 1 Audio Line-Out, 1 Microphone						
Internal USB		6 USB 2.0 ports available by three separate 2x5 headers. Each 2x5 header supports either one HP					
	Internal USB Port Kit	Internal USB Port Kit (EM165AA) or one Media Card Reader.					
Chassis Dimensions (H x W x D)	44.4 x 20.3 x 52.5 cm	(17.5 x 8.0 x 20.7 in)					
System Weight	Exact weights depend upon configuration Minimum config: 21.1kg (46.7lbs) Typical config: 22.8kg (50.4lbs) Maximum config: 29.2kg (64.3lbs)						
Temperature	Operating:	5° to 35° C (40° to 95° F)					
	Non-operating	-40° to 70° C (-40° to 158° F)					
Humidity	Operating:	8% to 85%					
	Non-operating	8% to 90%					
Maximum Altitude (non-	Operating:	3,000 m; 10,000 feet					
pressurized)	Non-operating	9,100 m; 30,000 feet					
Power Supply	Choice of:	·					
	recommended if 1279 The 1125W Power Su than 180V under all c The Z820 power supp 850W - http://www.p	can be drawn is 1125W. An uninterruptible power supply (UPS) is highly 5W output power is desired. pply can also supply 1450W of output power when the input voltage is greater onditions. oly efficiency reports can be found at these links: olugloadsolutions.com/psu_reports/HEWLETT%20PACKARD_623195-6201_850W_Report%20(2).pdf					
		plugloadsolutions.com/psu_reports/HEWLETT%20PACKARD_623196-					
Interfaces Supported	 001 ECOS%202921_1125W_Report(1275w).pdf 2-channel SATA 6.0 Gb/s Interface (2 channels e-SATA configurable) 4-channel SATA 3.0 Gb/s Interface 8-channel 6 Gb SAS interface (8 SAS connectors on the motherboard), SAS ports can be ported externally by using the SAS Bulkhead and/or Back Panel connector Kits USB 3.0, USB 2.0, IEEE 1394a 						
Hard Drive Controllers Supported	SATA and SAS control	llers					
Workstation ISV Certifications	See the latest list of c	ertifications at united-states/campaigns/workstations/partnerships.html					



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel Xeon E5-2600 Series - CTO				
	Intel® Xeon® Processor E5-2643 4C 3.30GHz	Υ	N		
	Intel® Xeon® Processor E5-2620 6C 2.00GHz	Υ	N		
	Intel Xeon E5-2600 Series - Z820 AMO				
	Z820 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	N	Υ	A6S97AA	
	Z820 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	N	Υ	A6S96AA	
	Z820 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	N	Υ	A6S95AA	
	Z820 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	N	Υ	A6S94AA	
	Z820 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	N	Υ	A6S93AA	
	Z820 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	N	Υ	A6S92AA	
	Z820 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	N	Υ	A6S91AA	
	Z820 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	N	Υ	A6S90AA	
	Z820 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	N	Υ	A6S89AA	
	Z820 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	N	Υ	A6S88AA	
	Z820 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	N	Υ	A6S87AA	
	Z820 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	N	Υ	A6S86AA	
	Z820 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	N	Υ	A6S85AA	
	Intel Xeon E5-2600 v2 Series - CTO				
	Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2687W v2 8C 3.40GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz	Υ	Υ		
	Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz	Υ	Υ		
	Intel Xeon E5-2600 v2 Series - Z820 AMO				
	Z820 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2	Υ	Υ	E2Q89AA	
	Z820 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2	Υ	Υ	E2Q88AA	
	Z820 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2	Υ	Υ	E2Q86AA	
	Z820 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2	Υ	Υ	E2Q85AA	



Υ

Z820 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2

E2Q87AA

Supported Components

Z820 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2	Υ	Υ	E2Q83AA
Z820 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	Υ	Υ	E2Q84AA
Z820 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	Υ	Υ	E2Q82AA
Z820 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	Υ	Υ	E2Q79AA
Z820 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	Υ	Υ	E2Q81AA
Z820 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	Υ	Υ	E2Q78AA
Z820 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	Υ	Υ	E2Q77AA
Z820 Xeon E5-2687W v2 8C 3.40 25MB 1866 CPU2	Υ	Υ	E2Q80AA
Z820 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	Υ	Υ	E2Q76AA
Z820 Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	Υ	Υ	E2Q75AA
Z820 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	Υ	Υ	E2Q74AA

Intel® Xeon® processors E5-2643, E5-2637 v2, E5-2643 v2, E5-2667 v2, E5-2687W v2, E5-2690 v2 and E5-2697 v2 REQUIRE the 1125W Power Supply Option.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP ZR30w 30-inch S-IPS LCD Monitor				
	HP ZR2740w 27-inch LED Backlit IPS Monitor				
	HP ZR2440w 24-inch LED Backlit IPS Monitor				
	HP Z Display Z24i 24-inch IPS LED Backlit Monitor				
	HP Z Display Z23i 23-inch IPS LED Backlit Monitor				
	HP Z Display Z22i 21.5-inch IPS LED Backlit Monitor				
	HP DreamColor LP2480zx Professional Display				

SAS Hard Drives		Factory	Option	Option Kit Part	Support
		Configured	Kit	Number	Notes
	HP SAS (Serial Attached SCSI) Hard Drives for HP W	Vorkstations			
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA	
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA	
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA	
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA	
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA	
	HP 900GB SAS 10K SFF HDD	Υ	Υ	E2P03AA	
	HP 1.2TB SAS 10K SFF HDD	Υ	Υ	E2P04AA	
	Sub-Section Description/Notes				

NOTE: NCQ (Native Command Queuing) not supported in Red Hat Enterprise Linux

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12

GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3

GB of system disk is reserved for system recovery software (Vista).

SATA Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations 3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD Υ QF298AA 2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD Υ Υ QB576AA 1TB SATA 7200 rpm 6Gb/s 3.5" HDD Υ Υ LQ037AA 500GB SATA 7200 rpm 6Gb/s 3.5" HDD Υ LQ036AA 250GB SATA 7200 rpm 6Gb/s 3.5" HDD LQ034AA

Supported C	omponents
-------------	-----------

300GB SATA 10K rpm SFF HDD	Υ	Υ	FX619AA
1TB SATA 10K rpm SFF HDD	Υ	Υ	B8X20AA
500GB SATA 10K rpm SFF HDD	Υ	Υ	B8X19AA
250GB SATA 10K rpm SFF HDD	Υ	Υ	B8X18AA
500GB SATA 7.2K SED SFF HDD	Y	Y	(not available today as After Market Option)

Sub-Section Description/Notes

Up to 5 SATA drives, 5 SAS, drives, or 6 SATA 2.5", Small Form Factor (SFF) drives 8 port SAS Controller included on the system board

SATA Solid State Drives HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD	Υ	Υ	A3D25AA	
HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA	
HP 512GB SATA 6Gb/s SSD	Υ	Υ	D8F30AA	
HP 1TB SATA 6Gb/s SSD	Υ	Υ	F3C96AA	
Samsung Enterprise 240GB SATA SSD	Υ	Υ	F0W94AA	
Samsung Enterprise 480GB SATA SSD	Υ	Υ	F0W95AA	
Intel Pro 1500 180GB SATA SSD	Υ	Υ	F5Z70AA	
HP 256GB SATA 6Gb/s SED Opal 1 SSD	Υ	Υ	D8N28AA	Note 1
HP 256GB SATA 6Gb/s SED Opal 2 SSD	Υ	Υ	G7U67AA	Note 1

Sub-Section Description/Notes

The 256GB Self-Encrypting Drive (SED) version has similar performance to the standard 256GB SSD. It

is also available in Opal 1.0 and Opal 2.0 versions

Options and Accesories 2.5" to 3.5" HDD Adapter

J5T63AA Sold

separately

PCIe SSDs PCIe SSDs for HP Workstations

HP Z Turbo Drive 512GB SSD*	Υ	Υ	G3G89AA
HP Z Turbo Drive 256GB SSD*	Υ	Υ	G3G88AA
Fusion ioFX 410GB PCIe Accelerator	Y	γ	F4W49AA

^{*} Each drive requires a PCIe x4 (minimum) slot to be available. Full performance is obtained only when using PCIe slots connected to the CPU. Non-CPU PCIe slots may see a decrease of up to 10%. Please see slot configuration recommendations at www.hp.com/go/zturbo. Note that graphics cards, Thunderbolt™, and other devices will require PCIe slots.

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Factory integrated RAID on motherboard for SAT	A drives			
	RAID 0 Configuration - Striped Array	Υ	N		See note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	N		See note 2
	RAID 1 Configuration - Mirrored Array	Υ	N		See note 3
	RAID 10 Configuration - Striped/Mirrored Array	Υ	N		



QuickSpecs

Supported Components

RAID 5 Configuration - Parity Array	Υ	N		See note 4
HP SAS Back Panel Connector kit				
HP SAS Back Panel Connector kit	Y	Y		Must have 4 or fewer SAS hard drives to configure this option
HP SAS Back Panel Bulkhead Connector Kit				
HP SAS Back Panel Bulkhead	Y	Y		HP SAS Back Panel Connector kit required. Internal SAS HD drives are not supported
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iE	BU07 Battery Ba	ackup Uni	t	
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	WE465AA	
LSI 9270-8i SAS 6Gb/s ROC RAID Card and iBBU9 Battery	/ Backup Unit			
LSI iBBU09 Battery Backup Unit	Υ	Υ	E0X19AA	
LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	E0X21AA	
Integrated SAS Controller				
Integrated LSI SAS 2308 Controller with RAID 0/1/1E/10	Υ	N		
Integrated SATA 6.0 Gb/s Controller				
Integrated SATA 6.0 Gb/s Controller	Υ	N		
Integrated SATA 3.0 Gb/s Controller				
Integrated SATA 3.0 Gb/s Controller	Υ	N		
RAID arrays greater than 2 TB in size are fully supported.				

NOTE 1: Minimum of 2 hard drives needed. All hard drives must be identical (size/speed/type/bus/functional capabilities). Must have 2. 3 or 4 HD Drives.

NOTE 2: Minimum of 3 SATA hard drives needed. All hard drives must be identical (size/speed/type/bus/functional capabilities).

At least 3 HD Drives required. May have 4th and 5th HD Drives. Drives must be the same drive (size/speed/type/functional capability).

NOTE 3: 2 SATA or 2 SAS hard drives required. All hard drives must be identical (size/speed/type/bus/functional

NOTE 4: Minimum of 3 SATA hard drives needed. All SATA hard drives must be identical (size/speed/type/bus/functional capabilities). Must have 3 or 4 HD Drives. 5 HD Drives not allowed.

NOTE: SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.

LSI RAID Definitions:

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux_hardware_matrix for details.



Supported Components

Graphics

			Option			orted
	Factory Configured	Option Kit	Kit Part Number	Support Notes	# of cards	Mixed?
Professional 2D						
NVIDIA NVS300 512MB Graphics	Υ	Υ	XP612AA		2	NO
NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA		2	NO
NVIDIA NVS 315 1GB Graphics	Υ	Υ	E1U66AA		2	NO
Entry 3D						
NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		2	NO
NVIDIA Quadro K600 1GB Graphics	Υ	Υ	C2J92AA		2	NO
AMD FirePro V3900 1GB Graphics	Υ	Υ	A6R69AA		1	NO
Mid-range 3D						
NVIDIA Quadro K2000 2GB Graphics	Υ	Υ	C2J93AA		3	NO
High End 3D						
NVIDIA Quadro K5000 4GB Graphics	Y	Y	C2J95AA	Contact Factory for support for greater than 2 cards	3	NO
AMD FirePro W7000 4GB Graphics	Y	Y	C2K00AA	Contact Factory for support for greater than 2 cards	2	NO
NVIDIA Quadro K4000 3GB Graphics	Y	Y	C2J94AA	Contact Factory for support for greater than 2 cards	2	NO
NVIDIA Quadro K6000 12GB Graphics	Y	Y	C2J96AA	Some configuration restrictions may exist. Contact Factory, as needed, for review.	2	NO
NVIDIA Quadro Sync	Υ	Υ	G5K57AA			

For configurations not listed in this specification, please contact the factory for review

High Performance GPU Computing		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	NVIDIA Tesla C2075 Compute Processor	Υ	Υ	QB035AA	Note #1
	NVIDIA Tesla K20c Compute Processor	Υ	Υ	C2J97AA	Note #2
	NVIDIA Tesla K40 Compute Processor	Υ	Υ	F4A88AA	Note #3
	Intel Xeon Phi 3120AIB Compute Processor	Υ	Υ	F8W20AA	Note #4
	Note #1: Up to two C2075 processors are supported				



Supported Components

Only supported with the Z820 1125W Chassis.

Must have add-in graphics card in addition to the C2075.

Supported Graphics cards are Quadro 600, Quadro 2000, and Quadro K6000.

Not supported in a configuration that has BOTH E5-2687 Processors and Quadro K6000 Graphics.

Note #2: Up to two K20 processors are supported. Only supported with the Z820 1125W Chassis. Must have add-in graphics card in addition to the K20. Supported Graphics cards are Quadro K600, Quadro K2000, and Quadro K5000.

Note #3: Up to two K40 processors are supported.

Only supported with the Z820 1125W Chassis.

Must have add-in graphics card in addition to the K40.

Supported Graphics cards are Quadro K600, Quadro K2000, and Quadro K5000.

Note #4:

- -1 card is supported
- -Card must be put in slot 6

Memory	сто	Option Kit Part Number	Support Notes
	DDR3-1866 ECC Unbuffered DIMMs - CTO		
	8GB DDR3-1866 ECC Unbuffered RAM		
	4GB DDR3-1866 ECC Unbuffered RAM		
	2GB DDR3-1866 ECC Unbuffered RAM		
	DDR3-1866 ECC Registered DIMMs - CTO	F1F33AA	
	32GB DDR3-1866 ECC Load Reduced (LR) RAM		Note 1
	16GB DDR3-1866 ECC Registered RAM		
	8GB DDR3-1866 ECC Registered RAM		
	4GB DDR3-1866 ECC Registered RAM		

Sub-Section Description/Notes

For details on the supported memory configurations on the HP Z820 Workstation, please refer to the System Technical Specifications - System Board section of this document.

DIMMs should be distributed across all four memory channels for optimal performance.

Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066MHz regardless of the specified speed of the memory.

NOTE: You cannot intermix registered and unbuffered DIMMs. The system will not work.

NOTE: You cannot intermix LR DIMMs with either registered or unbuffered DIMMs. The system will not work.

Note 1: 32GB DDR3-1866 LR DIMM - 1 DIMM/Channel runs at a maximum of 1866MHz and 2 DIMM/channel runs at a maximum of 1600MHz or as determined by the CPU whichever is lower.

AMO

DDR3-1600 ECC Registered DIMMs - AMO

32GB DDR3-1333 ECC Load Reduced (LR) RAM A2Z53AA

DDR3-1866 ECC Unbuffered DIMMs - AMO

HP 4GB (1x4GB) DDR3-1866 ECC RAM E2Q91AA HP 2GB (1x2GB) DDR3-1866 ECC RAM E2Q90AA



Supported Components

DDR3-1866 ECC Registered DIMMs - AMO

HP 4GB (1x4GB) DDR3-1866 ECC Reg RAM E2Q92AA
HP 8GB (1x8GB) DDR3-1866 ECC Reg RAM E2Q94AA
HP 16GB (1x16GB) DDR3-1866 ECC Reg RAM E2Q95AA
32GB DDR3-1333 ECC Load Reduced (LR) RAM F1F33AA

NOTE: You cannot intermix registered and unbuffered DIMMs. The system will not work.

NOTE: You cannot intermix LR DIMMs with either registered or unbuffered DIMMs. The system will not work

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel/Realtek HD ALC262 Audio	Υ	N		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Slot Load DVD+/-RW Drive	Υ	N		See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Υ	Y	QS208AA	
	HP 16X DVD-ROM SATA Drive (non Lightscribe)	Υ	Υ	AR629AA	See note 2
	HP Blu-ray Writer	Υ	Υ	AR482AA	
	HP DX115 Removable HDD Frame/Carrier	Υ	Υ	FZ576AA	
	HP 14-in-1 Media Card Reader	Υ	Υ	E5T42AA	
	HP 15-in-1 Media Card Reader	Υ	Υ	F4N90AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: May only order one. **NOTE 2**: Cannot be 2nd drive.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP IEEE 1394b FireWire PCIe Card	Υ	Υ	NK653AA	
	HP Thunderbolt-2 PCIe 1-port I/O Card*	Y	Y	F3F43AA	Available early 2014

^{*} Connect in a flash with 4X USB 3.0 bandwidth on an optional high-performance Thunderbolt™ 2.0 port.



Supported Components

Thunderbolt is new technology. Thunderbolt cable and Thunderbolt device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt Certified for Windows, see https://thunderbolttechnology.net/products.

Thunderbolt™ 2.0 is planned to be available via an optional add-in card in early 2014.

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N		
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA	See notes 1 and 2
	HP X520 10GbE Dual Port Adapter	Υ	Υ	C3N52AA	
	HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	
	HP 361T PCIe Dual Port Gigabit NIC	Υ	Υ	C3N37AA	See note 1
	Intel Ethernet I210-T1 PCIe	Υ	Υ	E0X95AA	

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

NOTE 2: This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on the Z820.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Security Cable with Kensington Lock	N	Υ	PC766A	
	HP Chassis Intrusion Sensor	Υ	N		
	HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	N	Υ	B8S55AA	

Input Devices				Option Kit	
		Factory Configured	Option Kit	Part Number	Support Notes
	HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB Smart Card Keyboard	Υ	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	N	Υ	WH343AA	
	HP PS/2 Keyboard	Υ	Υ	QY774AA	
	HP PS/2 Mouse	Υ	Υ	QY775AA	
	HP USB Keyboard	Υ	Υ	QY776AA	
	HP USB Optical Mouse	Υ	Υ	QY777AA	
	HP USB 1000dpi Laser Mouse	Y	Υ	QY778AA	

Supported Components

Product numbers QY774AA-QY778AA represent the new 2012 products with the updated product design. The previous models will be phased out over time.

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
	HP Internal USB Port Kit	N	Υ	EM165AA	Note 1	
	HP SAS Back Panel Connector Kit	N	Υ	EM164AA		
	HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	Note 2	
	HP Power Cord Kit	Υ	N			
	HP Workstation Mouse Pad	Υ	N		Japan Only	
	HP Optical Bay HDD Mounting Bracket	N	Υ	NQ099AA		
	HP ENERGY STAR Qualified Configuration	Υ	N			
	Note 1: The HP Internal USB Port kit has a single USB 2.0 type A connector. Note 2: No hot plug / hot swap supported with eSATA					

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		See note 1
	HP Remote Graphics Software (RGS) 6.0	Υ	N		See note 2
	HP ProtectTools Security	Υ	N		See note 3
	HP Power Assistant	Υ	N		
	PDF Complete - Corporate Edition	Υ	N		
	Cyberlink Media Suite & PowerDVD	Y	N		Media playback and authoring software
	MS Office Home & Business 2013	Υ	N		See note 4

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise, Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD

NOTE 4: Must be selected as a Configure to Order option. Delivered in the form of a "Drop in the Box" CD.

Operating Systems		Support Notes
	Genuine Windows® 7 Ultimate 64-bit	See note 1
	Genuine Windows® 7 Professional 64-bit	See note 1
	Genuine Windows® 7 Professional 32-bit	See note 1
	HP Linux Installer Kit	
	Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	See note 2
	Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit	
	Windows 8.1 Pro 64-bit	
	Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit (National Academic) Windows 8.1 Simplified Chinese Edition 64-bit	
	NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details. NOTE 2: This second OS must be ordered with the HP Linux Intaller Kit as the first OS.	



System Board	
System Board Form Factor	Custom Form Factor, 13" x 14.25" (330.20mm x 361.95mm)
Processor Socket	Dual LGA2011
CPU Bus Speed	QPI: Up to 8.0GT/sec
Chipset	Intel® C602 Chipset
Super I/O Controller	Nuvoton NPCD379H
Memory Expansion Slots	16 slots (8 slots per CPU)
Memory Type Supported	DDR3, RDIMM (Registered) or UDIMM (Unbuffered), ECC, LR (Load Reduction) DIMMs
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1066MHz, 1333MHz, & 1600MHz

		CPUO Bottom Slots				CPUO Top Slots				
Capacity (GR)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	
2	UDIMM	2GB								
4	UDIMM	2GB							2GB	
8	UDIMM	2GB		2GB			2GB		2GB	
8	UDIMM	4GB							4GB	
8	RDIMM	4GB							4GB	
16	UDIMM	4GB		4GB			4GB		4GB	
16	RDIMM	4GB		4GB			4GB		4GB	
24	UDIMM	4GB	2GB	4GB	2GB	2GB	4GB	2GB	4GB	
32	UDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	8GB		8GB			8GB		8GB	
48	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	
64	RDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	
64	RDIMM	16GB		16GB			16GB		16GB	
128	RDIMM	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	
128	RDIMM	32GB		32GB			32GB		32GB	
256	RDIMM	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	
Slot Loa	d Order	1	5	3	7	8	4	6	2	

System Technical Specifications

		Dual Processor															
		·	PUO Bot	tom Slot	s		CPU0 To	op Slots		(PU1 Bot	tom Slot	s		CPU1 To	p Slots	
Capacity (GB)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8
4	UDIMM	2GB								2GB							
16	UDIMM	2GB		2GB			2GB		2GB	2GB		2GB			2GB		2GB
32	UDIMM	4GB		4GB			4GB		4GB	4GB		4GB			4GB		4GB
32	RDIMM	4GB		4GB			4GB		4GB	4GB		4GB			4GB		4GB
32	RDIMM	8GB							8GB	8GB							8GB
48	UDIMM	4GB	2GB	4GB	2GB	2GB	4GB	2GB	4GB	4GB	2GB	4GB	2GB	2GB	4GB	2GB	4GB
64	RDIMM	8GB		8GB			8GB		8GB	8GB		8GB			8GB		8GB
96	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB
128	RDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB
128	RDIMM	16GB		16GB			16GB		16GB	16GB		16GB			16GB		16GB
256	RDIMM	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB
256	RDIMM	32GB		32GB			32GB		32GB	32GB		32GB			32GB		32GB
512	RDIMM	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB
Slot Loa	d Order	1	9	5	13	15	7	11	3	2	10	6	14	16	8	12	4

NOTE: CPU0 is located on the main system board. CPU1 (optional) is located on an add-in riser card.

Maximum Memory

Supports up to 128GB using UDIMMs Supports up to 256GB using RDIMMs Supports up to 512GB using LRDIMMs

Memory Configuration (Supported)

- Not all memory configurations possible are represented. Not all memory configurations shown are available as CTO. Please check Ordering Guide for supported configurations.
- Only ECC DIMMs are supported.
- UDIMM (Unbuffered), RDIMM (Registered) and LR DIMM (Load Reduction) memory cannot be mixed. All memory installed in the system must be either UDIMM or RDIMM or LR DIMMs.
- Do not install memory modules into memory slots if corresponding processor is not installed.
- Dual processor configurations with memory modules installed for only one processor is not supported.

PCI Express Connectors PCIe3 x16, gty 3 (gty 2 when optional 2nd CPU is not installed)

NOTE:

3rd PCIe x16 slot is ONLY available when 2nd CPU is installed. This is Slot #4 on the system board and is designated by a white-colored PCIe connector.

PCIe3 x16 (8), gty 1 (gty 0 when optional 2nd CPU is not installed)

NOTE:

This slot is ONLY available when 2nd CPU is installed. This is Slot #3 on the system board and is designated by a white-colored PCIe connector.

PCIe3 x8 (4), gty 1 (open-ended connector)



	PCIe2 x8 (4), qty 1 (open-ended connecto	or)
PCI Connectors (5.0V)	PCI 32b, 33MHz (supports 64-bit cards),	qty 1
Supported Drive		
Interfaces		
	SATA	Integrated 2-channel SATA 6.0Gb/sec controller and Integrated 4-channel 3.0Gb/sec controllers with RAID 0, 1, 5, 10 and NCQ. (Factory integrated RAID is Microsoft Windows only)
	Serial Attached SCSI	Integrated 8-channel SAS 6.0Gb/sec controller with HW RAID 0, 1, 10
	Integrated RAID	SATA: RAID 0, 1, 5, 10 SAS: HW RAID 0, 1, 10
ntegrated Graphics	None	
	Integrated Intel 82579 and 82574 Contro Memory Integrated 48KB receive buffer a Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802 Bus architecture PCIe 1.0a Data path width X1 to each controller Data path speed 2.5 Gb/s per direction tr Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V Al Boot ROM support Yes Network transfer rate 10BASE-T (half-du 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 1000BASE-TX (full-duplex) 2000 Mb/s Management capabilities: WOL, PXE 2.1,	and 8KB transmit buffer 2.3u compliant, 802.3x flow control ansfer rate JX supply uplex) 10 Mb/s
PCI-X Connectors	None	
PCI Card Guide	Yes	
Wake on LAN	Yes	
Integrated Trusted Platform Module	TPM 1.2	
SATA Connectors	6 ports/connectors (Included are 2 eSAT) kit) * No hot plug / hot swap supported with	A* configurable with optional eSATA* After-Market Option cable
IEEE 1394 Connector(s)	Front	Yes, 1394a
	Rear	Yes, 1394a
	Internal	None
USB Connector(s)	Front	2 USB 3.0
		1 USB 2.0
	Rear	2 USB 3.0 4 USB 2.0
	Internal	6 USB 2.0 ports available with three separate 2x5 headers. Each header supports either a HP Internal USB Port Kit (EM165AA) or USB Media Card reader.
		Each Internal Port Kit has one (1) USB 2.0 connector



		Third-Party adaptors are available to conve 2x5 headers to two USB 2.0 connectors. For solutions, the adaptor should include a mini 8 inches of cable between the 2x5 female coand the USB 2.0 connector to insure sufficie routing length.						
HD Integrated Audio	Realtek ALC262							
Flash ROM	Yes, SPI Rom							
CPU Fan Header	One header for the CPU fans a	and memory fans						
Chassis Fan Header	One Chassis Fan Header							
Front PCI Fan Header	2 Front PCI Fan Headers							
Front Control Panel/Speaker Header	Yes							
CMOS Battery Holder – Lithium	Yes							
	Integrated TPM 1.2							
Platform Module								
	Yes							
Power Switch, Power LED & Hard Drive LED Header	Front power switch, front pov header on system board	wer and hard drive L	.ED. Rear power sw	itch and rear power	LED. Drive LED			
Clear Password Jumper	Yes							
Serial Port	Yes, on rear panel							
Parallel Port	No							
Keyboard/Mouse	Yes							
Power Supply		850W 88% Efficio (Wide-Rangin		1125W/1275W*/1450W* 90% Efficient, Custom PSU (Wide-Ranging, Active PFC)				
Operating Voltage Rang	e	90-26	9 VAC	90-269 VAC				
Rated Voltage Range		100-127 VAC 200-240 VAC	118 VAC	100 VAC 115-127 VAC 200-240 VAC	118 VAC			
Rated Line Frequency		50-60 Hz	400 Hz	50-60 Hz	400 Hz			
Operating Line Frequenc	y Range	47-66 Hz	393-407 Hz	47-66 Hz	393-407 Hz			
Rated Input Current		11A @ 100-127 VAC 5.5A @ 200-240 VAC	11A @ 118 VAC	12A @ 100 VAC 12A @ 115-127 VAC 10A @ 200-240 VAC	12A @ 118 VAC			
Heat Dissipation (Config dependent)	uration and software	Typical = 2142 btu/hr (540kg-cal/hr) Max = 3335 btu/hr (840 kg-cal/hr) Max-1 = 3878 btu/hr (977 k Max-2 = 5002 btu/hr (120 cal/hr) Max-3 = 5624 btu/hr (147 cal/hr)			hr (977 kg-cal/hr) tu/hr (1260 kg- hr) tu/hr (1417 kg-			
Power Supply Fan		(2) 80x25 mm	variable speed	(2) 80x25 mm variable speed				
ENERGY STAR Qualified (Configuration dependen	t)	Ye	25	Ye	25			
80 PLUS® Compliant	-	V 000/	Efficient	Yes. 90%	Efficient			



System Technical Specifications

1							
		The Z820 850W power supply efficiency report can be found at this link: http://www.plugloadsolutions.com/ psu_reports/HEWLETT%20PACKARD 623195-001_ECOS%202620%201 850W_Report%20(2).pdf	The Z820 1125W power supply efficiency report can be found at this link: http://www.pluqloadsolutions.com/psu_reports/HEWLETT%20PACKARD _623196-001_ECOS% 202921_1125W_Report(1275w).pdf				
FEMP Standby Power Co (<2W in S5 - Power Off)	ompliant @115V	Yes	Yes				
EuP Compliant @ 230V (<0.5 W in S5 - Power Of	f)	Yes	Yes				
CECP Compliant @ 220V (<4W in S3 - Suspend to		Yes; Configuration dependent	Yes; Configuration dependent				
Power Consumption in s (as defined by ENERGY S (Instantly Available PC)	STAR) - Suspend to RAM (S3)	<15W	<35W				
Built-in Self Test LED	est LED Yes Yes						
Surge Tolerant Full Ran (withstands power surg		Yes	Yes				
			*Input voltage restriction				
	greater than 105V. If the inpumaximum power that can be recommended if 1275W outp The 1125W Power Supply car 180V under all conditions.	ply can also supply 1275W of output put voltage is less than 105V, but greate drawn is 1125W. An uninterruptible pout power is desired. In also supply 1450W of output power v	r than 90V for any reason, the wer supply (UPS) is highly				
AUX IN (audio)	No						
Clear CMOS Button	Yes						
Multibay Header	No						
Integrated Gigabit Ethernet	Yes, dual port.	es, dual port.					
Access Panel Solenoid Lock Header	No						
Access Panel Intrusion Sensor Header	Yes, as part of Front UI (Conti	rol Panel) cable header					
Memory Fan Connector	Yes, blind-mate						

System Configuration

Example Configuration	Processor Info								
#1	Memory Info	4x 2GB DDR3 1600 (UDIM	M)						
	Graphics Info	1x NVIDIA Quadro 2000							
	Disks/Optical/Floppy	1x 500GB SATA 7200/1x16X DVD-ROM SATA							
	Power Supply	850W 88% Custom PSU							
	Other	-							
Energy Consumption		115 VAC	230 VAC	100 VAC					
		LAN Enabled LAN Disabled	LAN Enabled LAN Disabled	LAN Enabled LAN Disabled					
	Windows Idle (S0)	75.5 W 73.9 W 75.5 W							
	Windows Busy Typ (S0)	156 W 149 W 155 W							



	Windows Busy Max (S0)	170	5 W	174 W		177 W	
	Sleep (S3)	4.35 W	3.87 W	4.51 W	4.06 W	4.37 W	3.87 W
	Off (S5)	1.68 W	1.28 W	1.85 W	1.45 W	1.67 W	1.27 W
	Zero Power Mode (ErP)	0.2	3 W	0.3	9 W	0.2	2 W
Heat Dissipation**		115	VAC	230	VAC	100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	258 btu/hr		252 btu/hr		258 btu/hr	
	Windows Busy Typ (S0)	532 b	tu/hr	508 btu/hr		529 btu/hr	
	Windows Busy Max (S0)	601 b	tu/hr	594 b	tu/hr	604 btu/hr	
	Sleep (S3)	14.8 btu/hr	13.2 btu/hr	15.4 btu/hr	13.9 btu/hr	14.9 btu/hr	13.2 btu/hr
	Off (S5)	5.73 btu/hr	4.37 btu/hr	6.31 btu/hr	4.95 btu/hr	5.70 btu/hr	4.33 btu/hr
	Zero Power Mode (ErP)	0.78 btu/hr		1.33 btu/hr		0.75 btu/hr	

Example Configuration	Processor Info	2v Intel Year	55-2640 (Si	iv-Core)					
#2		2x Intel Xeon E5-2640 (Six-Core)							
(ENERGY STAR	Memory Info	8x 2GB DDR3 1600 (UDIMM)							
QUALIFIED)	Graphics Info	1x NVIDIA Quadro 4000							
QUALIFIED)	Disks/Optical/Floppy	3x 500GB SATA 7200/1x16X DVD-ROM SATA							
	Power Supply	850W 88% C	ustom PSU						
	Other	-							
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	128 W		126 W		129 W			
	Windows Busy Typ (S0)	374 W		371 W		380 W			
	Windows Busy Max (S0)	432 W		425 W		434 W			
	Sleep (S3)	5.78 W	5.35 W	5.91 W	5.48 W	5.81 W	5.37 W		
	Off (S5)	2.57 W	1.14 W	2.74 W	1.31 W	2.56 W	1.13 W		
	Zero Power Mode (ErP)	0.2	3 W	0.39 W		0.22 W			
Heat Dissipation**		115	VAC	230	VAC	100	VAC		
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	437 b	tu/hr	430 b	tu/hr	440 b	tu/hr		
	Windows Busy Typ (S0)	1276	otu/hr	1266	otu/hr	1297	btu/hr		
	Windows Busy Max (S0)	1474	otu/hr	1450	otu/hr	1481	btu/hr		
	Sleep (S3)	19.7 btu/hr	18.3 btu/hr	20.2 btu/hr	18.7 btu/hr	19.8 btu/hr	18.3 btu/hr		
	Off (S5)	8.77 btu/hr	3.89 btu/hr	9.35 btu/hr	4.47 btu/hr	8.74 btu/hr	3.86 btu/hr		
	Zero Power Mode (ErP)	0.78 t	tu/hr	1.33 t	tu/hr	0.75 l	otu/hr		

Example Configuration	Processor Info	2x Intel Xeon E5-2680 (Eight-Core)							
#3	Memory Info	8x 4GB DDR3	1600 (RDIM	M)					
	Graphics Info	1x NVIDIA Qu	adro 6000						
	Disks/Optical/Floppy	2x 300GB SAS 15K/1x16X DVD+-RW SuperMulti SATA							
	Power Supply	1125W 90% Custom PSU							
	Other	-							
Energy Consumption		115 VAC		230 VAC		100 VAC			
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	152	2 W	150 W		153 W			
	Windows Busy Typ (S0)	507	7 W	498	B W	509 W			
	Windows Busy Max (S0)	614 W		603 W		617 W			
	Sleep (S3)	7.62 W	7.14 W	7.66 W	7.23 W	7.61 W	7.17 W		



	Off (S5)	1.81 W	1.40 W	1.97 W	1.58 W	1.79 W	1.39 W
	Zero Power Mode (ErP)	0.2	3 W	0.3	9 W	0.2	2 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	519 b	tu/hr	512 b	tu/hr	522 b	tu/hr
	Windows Busy Typ (S0)	1730	btu/hr	1699	btu/hr	1737	btu/hr
	Windows Busy Max (S0)	2095	btu/hr	2058	btu/hr	2105	btu/hr
	Sleep (S3)	26.0 btu/hr	24.4 btu/hr	26.1 btu/hr	24.7 btu/hr	26.0 btu/hr	24.5 btu/hr
	Off (S5)	6.18 btu/hr	4.78 btu/hr	6.72 btu/hr	5.39 btu/hr	6.11 btu/hr	4.74 btu/hr
	Zero Power Mode (ErP)	0.78 t	otu/hr	1.33 l	otu/hr	0.75 l	otu/hr

Formula Confirmation	D	2x Intel Xeon E5-2687 (Eight-Core)					
Example Configuration	Processor Info						
#4	Memory Info	16x 4GB DDR3 1600 (RDIMM)					
	Graphics Info	2x NVIDIA Quadro 5000					
	Disks/Optical/Floppy	4x 300GB SA	S 15K/1x16X	(DVD+-RW S	uperMulti SA	TA	
	Power Supply	1125W 90%	Custom PSU				
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	232 W		228 W		232 W	
	Windows Busy Typ (S0)	783 W		748 W		777 W	
	Windows Busy Max (S0)	896 W		878 W		902 W	
	Sleep (S3)	10.9 W	10.5 W	10.9 W	10.5 W	11.0 W	10.5 W
	Off (S5)	1.80 W	1.40 W	2.00 W	1.58 W	1.79 W	1.38 W
	Zero Power Mode (ErP)	0.2	3 W	0.39 W		0.22 W	
Heat Dissipation**		115	VAC	230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	792 b	tu/hr	778 btu/hr		792 btu/hr	
	Windows Busy Typ (S0)	2672 btu/hr		2552 btu/hr		2651 btu/hr	
	Windows Busy Max (S0)	3057	btu/hr	2996 btu/hr		3078 btu/hr	
	Sleep (S3)	37.2 btu/hr	35.8 btu/hr	37.2 btu/hr	35.8 btu/hr	37.5 btu/hr	35.8 btu/hr
	Off (S5)	6.14 btu/hr	4.78 btu/hr	6.82 btu/hr	5.39 btu/hr	6.11 btu/hr	4.71 btu/hr
	Zero Power Mode (ErP)	0.78 t	otu/hr	1.33 l	otu/hr	0.75 l	otu/hr

Example Configuration	Processor Info	2x Intel Xeor	n 2687W (Eigl	ht-Core)				
#5	Memory Info	16x 32GB DDR3 1600 (LRDIMM)						
(ENERGY STAR QUALIFIED)	Graphics Info	1x NVIDIA Qu	1x NVIDIA Quadro 6000					
	Disks/Optical/Floppy	2x 3TB SATA/1x 16X DVD+-RW SuperMulti SATA						
	Power Supply	1125W 90% Custom PSU						
	Other	-						
Energy Consumption		115 VAC		230 VAC		100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	On-Idle (ENERGY STAR® Idle (SO))	212	2 W	210	0 W	213	3 W	
	ENERGY STAR® PMAX Windows running Linpack and Viewperf	690	o W	678	8 W	700) W	
	ENERGY STAR® "Sleep" (S3)	31.9 W		31.5 W		32.2 W		



	ENERGY STAR® "Standby" (Off) (S5)	1.35 W		1.50 W		1.35 W	
Heat Dissipation**		115	VAC	230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	On-Idle (ENERGY STAR® Idle (SO))	723 btu/hr		717 btu/hr		727 btu/hr	
	ENERGY STAR® PMAX Windows running Linpack and Viewperf	2354 btu/hr		2313 btu/hr		2389 btu/hr	
	ENERGY STAR® "Sleep" (S3)	109 btu/hr		107 btu/hr		110 btu/hr	
	ENERGY STAR® "Standby" (Off) (S5)	4.61 btu/hr		5.12 btu/hr		4.61 btu/hr	

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration	Processor Info	Dual Intel Xeon E5-2660 2.20 GHz with Standard Heatsinks		
(Entry level)	Memory Info	4 - DDR3 2 GB 1600 MHz UDIMM		
	Graphics Info	Single NVIDIA Quadro NVS 300		
	Disks/Optical/Floppy	Single Blu-ray BD-R Single 1 TB 7200 RPM SATA 3.5" HDD		

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	4.0	23
	Hard drive Operating (random reads)	4.1	23
	DVD-ROM Operating (sequential reads)	4.7	34

System Configuration	Processor Info	Dual Intel Xeon E5-2687W 3.10 GHz with Liquid Cooling
(High-end)	Memory Info	16 - DDR3 4 GB 1600 MHz RDIMM
Graphics Info Dual NVIDIA Quadro 6000 Disks/Optical/Floppy Single Blu-ray BD-R		Dual NVIDIA Quadro 6000
		Single Blu-ray BD-R
		Dual 600 GB 15K RPM SAS 3.5" HDD

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	5.2	32
	Hard drive Operating (random reads)	5.1	33
	DVD-ROM Operating (sequential reads)	5.3	36

Environmental	Temperature	Operating: 5° to 35° C (40° to 95° F)
Requirements		Non-operating: -40° to 60° C (-40° to 140° F)



Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
Maximum Altitude	Operating: 3,000 m (10,000 feet) Non-operating: 9,100 m (30,000 feet)
Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.
Cooling	Above 1524 m (5000 ft) altitude, maximum operating temperature is derated by 1° C (1.8° F) per 305 m (1000 ft) elevation increase

Physical Security a	nd Serviceability
Access Panel	Tool-less
	Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less, retained by Front PCI Card Guide
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	No
Rear Port Control Cover	No
Serial, Parallel, USB,	Yes



Audio, Network, Enable/Disable Port Control	
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	No
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A torx driver (T15) is needed to remove the CPU heatsink(s) before the CPU can be removed. CPU removal is tool-less
Power Supply Diagnostic LED	Yes
Front Power Button	Yes
Front Power LED	Yes, blue (normal), red (fault)
Front Hard Drive Activity LED	Yes, green
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS
Cooling Solutions	Air cooled forced convection, liquid cooling (optional)
Power Supply Fans	2x - 80mm x 25mm
CPU Heatsink Fan	92 x 25mm 5-wire PWM for each CPU
Chassis Fan	Rear: 2x - 92mm x 25mm Front (850W config): 1x - 92mm x 25mm (upper position) Front (1125W config): 2x - 92mm x 25mm
Memory Heatsink Fan	3x - 75 x 90 x 35mm memory blowers 80 x 25 mm 4-wire PW fan
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to: Run diagnostics View the hardware configuration of the system
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision Diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are: • Testing and diagnosing apparent hardware failures
	Documenting system configurations for upgrade planning, standardization, inventory



	 tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis 			
	Schaing configuration information to another tocation for more in depth analysis			
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including optical and flopp drives			
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).			
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 			
Trusted Platform Module Chip with optional ProtectTools Software	Yes			
Integrated Chassis Handles	Yes, front and rear			
Power Supply	Tool-less, direct-connect (blind-mate)			
PCIe Card Retention	Yes, rear (all), middle (full-height cards), front (full-length with extender cards)			
Flash ROM	Yes. SPI ROM			
Diagnostic Power Switch LED on board	Yes			
Clear Password Jumper	Yes			
Clear CMOS Button	Yes			
CMOS Battery Holder	Yes			
DIMM Connectors	Yes			
HP ProtectTools Security Manager	Yes - not supported on Linux			

BIOS		
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4. BIOS supports 32 and 64-bit Operating systems.	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.	
BBS	BIOS Boot Specification v1.01	
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.	
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	
BIOS Power On	Users can define a specific date and time for the system to power on.	
ROM Based Computer Setup Utility (F10)	Review and customize system settings controlled by the BIOS.	
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Replicated Setup	Saves BIOS settings to diskette or USB flash drive in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility	



	(F10 setup).		
SMBIOS	System Management BIOS 2.7, for system management information		
Boot Control	Disables the ability to boot from removable media on supported devices.		
Memory Change Alert	Alerts management console if memory is removed or changed.		
Thermal Alert	 Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. 		
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.		
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and wake from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-Bit operating systems.		
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.		
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.		
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.		
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.		
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.		
System board revision level	Allows management SW to read the revision level of the system board Revision level is digitally encoded into the HW and cannot be modified.		
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.		
Auto Setup when new hardware installed	System automatically detects addition of new hardware.		
Keyboard-less Operation			
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.		
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memory.		
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.		
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics.		
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED.		
Industry Standard Specification Support			
UEFI Specification Revision	2.3.1		
Industry Standard	Revision Supported by the BIOS		



System Technical Specifications

ACPI	Advanced Configuration and Power Management Interface, Version 2.0c			
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b			
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0			
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 			
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0			
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7 			
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0			
PMM	POST Memory Manager Specification, Version 1.01			
SATA	Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0			
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B			
TPM	Trusted Computing Group TPM Specification Version 1.2			
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1			
USB	 Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification 			
SMBIOS	System Management BIOS Reference Specification, Version 2.7			

Social and Environmental Responsibility

Social and Environi	mental Kesponsibility	
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:	
	 ENERGY STAR® (energy-saving features available on selected configurations-Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration 	
	* This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'	
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal	
	The battery in this product does not contain:	
	Mercury greater than 5ppm by weight	
	 Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight 	
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the	

	Environment. http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf		
	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.		
Low Halogen Statement	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: 3 ½" SAS HDDs, LSI 9260-8i SAS 6Gb/s ROC RAID Card, Liquid Cooling Solution and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.		
and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.		
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html Eco-label certifications http://www.hp.com/hpinfo/qlobalcitizenship/environment/productdesign/ecolabels.html		
	ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html		
Additional Information	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product is >90% recycle-able when properly disposed of at end of life. EPEAT Gold registered in the U.S. EPEAT registration varies by country. See www.epeat.net for		
Packaging	registration status by country HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/qlobalcitizenship/society/qen_specifications.html		
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting 		
Packaging Materials			
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).		
External	Outer carton, accessories carton, and insert made of corrugated paper board.		

Manageability	
Industry Standard	This product meets the following industry standard specifications for manageability functionality:



Specifications	DASH 1.1 (via Intel LAN on motherboard)
Intel Active Management Technology (AMT)	Intel Active Management Technology (AMT) 7.0 An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions: Power Management (on, off, reset) Hardware Inventory (includes BIOS and firmware revisions) Hardware Alerting Agent Presence System Defense Filters SOL/IDER Cisco NAC/SDN Support ME Wake-on-LAN DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration Management Engine (ME) firmware roll back
Intel® vPro™ Technology	The HP Z820 Workstation supports Intel vPro technology when configured as outlined below: Intel Xeon processor E5-2600 product family featuring Intel vPro Technology Intel C602 chipset Intel 82579LM GbE LAN
Remote Manageability Software Solutions	The HP Z820 Workstation is supported on the following remote manageability software consoles: • LANDesk Management Suite (HP recommended solution) • Microsoft System Center Configuration Manager • HP Client Automation Enterprise For questions or support for manageability needs, please visit http://www.hp.com/qo/easydeploy
System Software	For questions or support for SSM, please visit: http://www.hp.com/qo/ssm
Manager Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.



System Technical Specifications

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/qo/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

	Januario	······································
Processors	Product #	Offering
	A2A32AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU
	A2A35AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU
	A2A46AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU
	A2A49AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU
Hard Drives	Product #	Offering
	QJ686AV	500GB 7200 RPM SATA 1st HDD
	QJ697AV	500GB 7200 RPM SATA 2nd HDD
	QJ709AV	500GB 7200 RPM SATA 3rd HDD
	QJ721AV	500GB 7200 RPM SATA 4th HDD
	QJ733AV	500GB 7200 RPM SATA 5th HDD
	QJ687AV	1TB 7200 RPM SATA 1st HDD
	QJ698AV	1TB 7200 RPM SATA 2nd HDD
	QJ710AV	1TB 7200 RPM SATA 3rd HDD
	QJ722AV	1TB 7200 RPM SATA 4th HDD
	QJ734AV	1TB 7200 RPM SATA 5th HDD
Graphics	Product #	Offering
	A7U55AV	NVIDIA NVS 310 512MB GFX
	A7U56AV	NVIDIA NVS 310 512MB 2nd GFX
Memory	Product #	Offering
		TBD
Optical and Removable	Product #	Offering
Storage	QG250AV	16X SuperMulti DVDRW SATA 1st ODD
Input Devices	Product #	Offering
	A8Z58AV	HP USB Keyboard
	A8Z60AV	HP USB Optical Mouse
Operating Systems	Product #	Offering
	QG517AV	Windows 7 Professional 64bit OS



Technical Specifications - Processors

Processors Intel® Xeon® Processor E5-2620 6C 2.00GHz

Intel® Xeon® Processor E5-2643 4C 3.30GHz

Introduction

The Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families are the next generation of 64-bit, multi-core enterprise processors built on 32-nanometer process technology. Throughout this document, the Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families may be referred to as simply the processor. Where information differs between the EP and EP 4S SKUs, this document uses specific Intel® Xeon® processor E5-1600 product family, Intel® Xeon® processor E5-2600 product family, and Intel® Xeon® processor E5-4600 product family notation. Based on the low-power/high performance 2nd Generation Intel® Core™ Processor Family microarchitecture, the processor is designed for a two chip platform consisting of a processor and a Platform Controller Hub (PCH) enabling higher performance, easier validation, and improved x-y footprint. The Intel® Xeon® processor E5-1600 product family are designed for Efficient Performance server, workstation and HPC platforms. The Intel® Xeon® processor E5-4600 product family processor supports scalable server and HPC platforms of two or more processors, including "glueless" 4-way platforms. Note: some processor features are not available on all platforms.

These processors feature per socket, two Intel® QuickPath Interconnect point-to-point links capable of up to 8.0 GT/s, up to 40 lanes of PCI Express* 3.0 links capable of 8.0 GT/s, and 4 lanes of DMI2/PCI Express* 2.0 interface with a peak transfer rate of 5.0 GT/s. The processor supports up to 46 bits of physical address space and 48-bit of virtual address space. Included in this family of processors is an integrated memory controller (IMC) and integrated I/O (IIO) (such as PCI Express* and DMI2) on a single silicon die. This single die solution is known as a monolithic processor.

Performance and Features

- Up to 8 execution cores
- Each core supports two threads (Intel® Hyper-Threading Technology), up to 16 threads per socket
- 46-bit physical addressing and 48-bit virtual addressing
- 1 GB large page support for server applications
- A 32-KB instruction and 32-KB data first-level cache (L1) for each core
- A 256-KB shared instruction/data mid-level (L2) cache for each core
- Up to 20 MB last level cache (LLC): up

Z820 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	A6S85AA
Z820 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	A6S86AA
Z820 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	A6S87AA
Z820 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	A6S88AA
Z820 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	A6S89AA
Z820 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	A6S90AA
Z820 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	A6S91AA
Z820 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	A6S92AA
Z820 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	A6S93AA
Z820 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	A6S94AA
Z820 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	A6S95AA
Z820 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	A6S96AA
Z820 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	A6S97AA

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Technical Specifications - Processors

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Performance and Features

- Up to 8 execution cores
- Each core supports two threads (Intel® Hyper-Threading Technology), up to 16 threads per socket
- 46-bit physical addressing and 48-bit virtual addressing
- 1 GB large page support for server applications
- A 32-KB instruction and 32-KB data first-level cache (L1) for each core
- A 256-KB shared instruction/data mid-level (L2) cache for each core
- Up to 20 MB last level cache (LLC): up to 2.5 MB per core instruction/data last level cache (LLC), shared among all cores

Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz Intel® Xeon® Processor E5-2687W v2 8C 3.40GHz Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz Z820 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2 Z820 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2 Z820 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2 Z820 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2 Z820 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2 Z820 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2

E2Q89AA E2Q88AA E2Q86AA E2Q85AA

E2Q87AA E2Q83AA



Technical Specifications - Processors	
Z820 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	E2Q84AA
Z820 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	E2Q82AA
Z820 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	E2Q79AA
Z820 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	E2Q81AA
Z820 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	E2Q78AA
Z820 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	E2Q77AA
Z820 Xeon E5-2687W v2 8C 3.40 25MB 1866 CPU2	E2Q80AA
Z820 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	E2Q76AA
Z820 Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	E2Q75AA
Z820 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	E2Q74AA



3.5 in: 8.9 cm

0.2 ms

3.4 ms

6.6 ms

Technical Specifications - Hard Drives

HP SAS (Serial Attached
SCSI) Hard Drives for HP
Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 600GB
Height 1 in; 2.54 cm
Width Media Diameter

Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6.0 Gb/s
Rate (Maximum)

kate (Maximum)

Buffer 16 MB
Seek Time (typical reads, Single Track

includes controller overhead, including settling)

Average
Full Stroke

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks **Operating Temperature** 50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 450GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s
Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 ms
3.4 msFull Stroke6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 300GB
Height 1 in; 2.54 cm
Width Media Diame

dth Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s
Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.4 ms6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

Technical Specifications - Hard Drives

HP	300	GB S	AS 1	OK	SFF
HD	n				

 Capacity
 300GB

 Height
 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controller overhead, including settling)Single Track o.4 ms (max)Average settling)3.6 msFull Stroke7.3 ms

Rotational Speed 10,000 rpm Logical Blocks 585,937,500

Operating Temperature 41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF

Capacity600GBHeight0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s
Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controller overhead, including settling)Single Track o.4 ms (max)Average study3.6 msFull Stroke7.3 ms

Rotational Speed 10,000 rpm **Logical Blocks** 1,172,123,568

Operating Temperature 41° to 131° F (5° to 55° C)

HP 900GB SAS 10K SFF HDD

 Capacity
 900GB

 Height
 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s
Rate (Maximum)

Buffer 64MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2ms (max)Average
Full Stroke3.5ms7.0ms

Rotational Speed 10,000 rpm **Logical Blocks** 1,758,174,767

Operating Temperature 41° to 131° F (5° to 55° C)

HP 1.2TB SAS 10K SFF HDD

Capacity Height

1.2TB

0.6 in: 1.53 cm Width **Media Diameter**

2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, includes controller overhead, including settling)

Average Full Stroke

Single Track

0.18ms (max) 3.5ms 7.17ms

1.2ms (typical)

Rotational Speed 10.000 rpm **Logical Blocks** 2,344,225,968

Operating Temperature 41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard **Drives for HP** Workstations

250GB SATA 10K rpm SFF Capacity HDD

250GB Height

0.6 in; 1.53 cm Width **Media Diameter**

2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical reads, **Single Track** includes controller

Average

3.6ms **Full Stroke** 9.0ms (typical)

overhead, including settling)

Rotational Speed 10K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

500GB SATA 10K rpm SFF Capacity HDD

500GB Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical reads, **Single Track** 1.2ms (typical)

includes controller	Average	3.6ms
overhead, including	Full Stroke	9.0ms (typical)

Rotational Speed 10K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 10K rpm SFF HDD Capacity 1TB
Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s)
Synchronous Transfer Up to 600 MB/s
Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical reads,
includes controller
overhead, including
cottling)Single Track
Average1.2ms (typical)Average
Full Stroke3.6ms9.0ms (typical)

settling) Full Stro Rotational Speed 10K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity250 GBHeight1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4.0 in; 10.17 cm

Up to 600MB/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

Buffer 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 ms11 ms
5 Pull Stroke21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity500GBHeight1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, **Single Track** 2 ms includes controller Average 11 ms overhead, including **Full Stroke** 21 ms settling)

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1 Terabyte (1000 GB) Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4.0 in; 10.17 cm

Up to 600 MB/s

2 ms

11 ms

21 ms

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

32MB

Seek Time (typical reads, **Single Track** includes controller Average overhead, including **Full Stroke**

settling)

Buffer

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2.0TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Rate (Maximum)

Up to 600 MB/s

Buffer 64MB

Seek Time (typical reads, **Single Track** 1.0 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 18 ms settling)

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 3.0TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)



Buffer 64MB

Seek Time (typical reads, **Single Track** 0.6 ms includes controller **Average** 11 ms overhead, including **Full Stroke Not Specified**

settling)

Rotational Speed 7,200 rpm

Operating Temperature 41° to 140° F (5° to 60° C)

500GB SATA 7.2K SED SFF Capacity

HDD

Height 0.275 in; 0.7 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

500GB

Interface Serial ATA (6Gb/s) Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads, **Single Track** 1ms includes controller Average 4.2ms overhead, including **Full Stroke** 25ms (typical)

settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

300GB SATA 10K rpm SFF Capacity

HDD

300,069,052,416 bytes Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Up to 300 MB/s

Cache 16 MB

Seek Time (typical reads, **Single Track**

includes controller **Average** overhead, including **Full Stroke**

settling)

Rotational Speed 10,000 rpm **Logical Blocks** 586,072,368

Operating Temperature 41° to 131° F (5° to 55° C)

HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD

Capacity 128GB Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer Rate (Maximum)

Operating Temperature

32° to 158° F (0° to 70° C)

Up to 500MB/s (Sequential Read)

0.7 ms (maximum)

4.4 ms

9.5 ms

Technical Specifications - Hard Drives

HP 256GB SATA 6Gb/s Capacity

SSD

Height 0.28 in; 0.7 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

256GB

HP 256GB SATA 6Gb/s

SED SSD

Capacity 256GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s

SSD

Capacity 512GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 1TB SATA 6Gb/s SSD Capacity 1TB

> Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)

2.5 in; 6.36 cm

Operating Temperature 32° to 158° F (0° to 70° C)

Samsung Enterprise

240GB SATA SSD

Capacity 240GB

Width **Physical Size**

Interface SATA 6Gb/s **Synchronous Transfer** 600 Mb/s

Rate (Maximum)

Samsung Enterprise

480GB SATA SSD

Intel Pro 1500 180GB

SATA SSD

Capacity 480GB

Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s **Synchronous Transfer** 600 Mb/s

Rate (Maximum)

Capacity

180GB

Width **Physical Size** 2.5 in; 6.36 cm

Technical Specifications - Hard Drives

Interface6Gb/s SATASynchronous Transfer600 Mb/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Opal 1 SSD
 Capacity
 256 GB

 Height
 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Rate (Maximum)

sfer 550 Mb/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Opal 2 SSD
 Capacity
 256 GB

 Height
 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Rate (Maximum)

550 Mb/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

PCIe SSDs for HP Workstations

HP Z Turbo Drive 256GB

SSD

Capacity 256GB

Interface PCI Express 2.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

HP Z Turbo Drive 512GB

SSD

Capacity 512GB

Interface PCI Express 2.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Fusion ioFX 410GB PCle

Accelerator

Capacity 410GB

Interface PCI Express 2.0 x4 electrical x4 physical

Operating Temperature 32° to 95° F (0° to 35° C)



Technical Specifications - Hard Drive Controllers

LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iBBU07 Battery Backup Unit PCI Bus PCI-Express (Gen2) V2.0 x8 lanes

PCI Modes Bus Master DMA
RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Data Burst Transfer Up to 4GB/s

Rate

PCI Card Type Low profile, single PCIe slot design with full height bracket.

The optional iBBU07 Battery Backup unit mounts on the controller card and

the assembly remains within a single PCIe slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None **Maximum Number of SCSI** 32.

Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Connector LEDs indicate whether the internal connector is active for ports

0-3 and 4-7

LSI 9270-8i SAS 6Gb/s ROC RAID Card and iBBU9 Battery Backup Unit **PCI Bus** x8 lane PCIe 3.0 compliant

RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Card Type Low profile, single PCIe slot design with full height bracket.

PCI Voltage +3.3V Add-in Card
PCI Power +3.3V, +12V
Certification Level PCI-Express 3.0

IO Bus Eight 6Gb/s and 3Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4 (Mini-SAS)

External Connectors None

Maximum Number of SCSI Up to 128 SAS and/or SATA hard drives and SSDs

Devices Note: HP Workstations do not support this many internal drives.

LED Indicators Heartbeat LED on card

Technical Specifications - Graphics

NVIDIA NVS 300 512MB Graphics

Form Factor 2.7 inches (H) x 5.7 inches (L), Half-Height

Graphics Controller NVIDIA NVS 300 Graphics Board Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

Connectors DMS-59

Includes DMS-59 to Dual DVI-I adapter

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapter

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution DVI: two digital displays up to 1920 x 1200

DisplayPort: two digital displays up to 2560 x 1600 $\,$

VGA: two analog displays up to 1920 x 1080

Image Quality Features

Display Output This card support up to two displays:

 Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking

 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)

 Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

Supported Graphics APIs OGL 3.3

DirectX 10.1

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: tp://download.nvidia.com/novell or http://www.nvidia.com/novell or <a href="http://www

Power Consumption <18 Watts

NVIDIA NVS 310 512MB Graphics **Form Factor** Low Profile:

2.713 inches in height × 6.150 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 310

GPU: GF119-825

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3 Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort

Maximum Resolution Image Quality Features Up to 2560 x 1600 (digital display) per display.

The following video formats are supported:

- MPEG2
- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support
- Support for 3D Blu Ray
- VC1
- DivX version 3.11 and later
- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics APIs DX11, OpenGL 4.1 **Available Graphics**

Shader Model 5.0

Windows 8

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

Note

19.5 Watts

The thermal solution used on this card is an active fan heatsink.
 Factory configured NVS 310 graphics card have no cable adpaters

included. Adapters must be ordered separately.

3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

NVIDIA NVS 315 1GB Graphics

Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 315 (using GF119-825 GPU)

Number of Cores: 48 CUDA cores

Max. Power: 19.3W

Cooling Solution: Active fan heatsink

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 1GB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors DMS-59 output

Cables included:

- For CTO: DMS-59 to DVI cable

- For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable

Maximum Resolution

Maximum number of displays supported: 2

Maximum Resolution Support:

DMS-59 to VGA: 2048 x 1536 @ 85Hz
 DMS-59 to DVI: 1980 x 1200 @ 60Hz
 DMS-59 to DP: 2560 x 1600 @ 60Hz

Image Quality Features

See Display Output section.

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support - Support for 3D Blu Ray

VC1

- DivX version 3.11 or later

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides

improved video playback speeds via faster decode and transcode.

Display Output Up to 2 displays using one of the following DMS-59 cables:

DMS-59 to DVI DMS-59 to VGA

DMS-59 to DP

DisplayPort output:

- Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor

VGA display output:

- Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.

Shading Architecture Supported Graphics APIs DX11, OpenGL 4.3

Shader Model 5.0

Available Graphics

Windows 8

Drivers

Microsoft Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

1. The thermal solution used on this card is an active fan heatsink. 2. Factory configured graphics card includes DMS-59 to DVI cable. 3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA

cables (one each).

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

GPU: GK107

Bus Type PCI Express x16, 3.0 compliant

Memory Size: 512MB DDR3 Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

Maximum Resolution VGA (through DVI to VGA cable):

2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

3840 × 2160 × 36 bpp at 60 Hz

RAMDAC 400 MHz integrated RAMDAC

Display Output Maximum number of displays supported: 2

Shading Architecture Shader Model 5.0 Supported Graphics APIs DX11, OpenGL 4.2 Windows 8

Available Graphics

Drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

1. Factory configured Quadro 410 does not include any video adapters. **Notes**

Adapters must be ordered separately.

2. Option kit Quadro 410 includes one DP to DVI-D adapter

NVIDIA Quadro K600 1GB Form Factor

Graphics

2.731" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

Graphics Controller NVIDIA Quadro K600 Graphics Card

> Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts PCI Express 2.0 x16

Bus Type 1 GB GDDR3, 891 Mhz Memory 128-bit memory I/O path 29 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 1 DisplayPort output

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

10-bit scan-out support

Display Output

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

VGA:

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to the Quadro K600 DisplayPort connector at this resolution)

Max number of daisy-chained monitors: 2
 Full Microsoft DirectX 11 Shader Model 5.0

Shading Architecture

-ull Microsoft Directa 11 Shau

Supported Graphics APIs OpenGL 4.3 DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

- Quadro K600 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- 2. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. Quadro K600 is Windows 8 Compliant.
- A total maximum of 2 active monitors are supported across all display output types.

AMD FirePro V3900 1GB Graphics

Form Factor
Graphics Controller

Full height, half length (full-height bracket included)

AMD FirePro™ V3900 professional graphics



Bus Type PCI Express® x16, Generation 2.1

Memory 1GB DDR3 memory **Connectors** 1 DL DVI, 1 DP output

One DP to DVI adapter included

Maximum Resolution 2560x1600 per display (5120x1600 max. horizontal resolution) **Display Output**

1 DisplayPort® 1.2 1 Dual-link DVI

Available Graphics

Drivers

Supported Graphics APIs OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details.

NVIDIA Quadro K2000 2GB Graphics

4.38" H x 7.97" L Form Factor

Single Slot, Full Height

NVIDIA Quadro K2000 Graphics Card **Graphics Controller**

> Kepler GK107 GPU 384 CUDA cores Max Power: 51.1 Watts

Bus Type PCI Express 2.0 x16 Memory 2 GB GDDR5, 2000 Mhz 128-bit memory I/O path 64 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 2 DisplayPort outputs CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

10-bit scan-out support

Display Output

VGA:

requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K2000 DisplayPort connector at this resolution)
 Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K2000 DisplayPort connector: 4 with maximum resolution of 1920 x 1200

Maximum number of monitors across all available Quadro K2000 outputs is α

Shading Architecture

Full Microsoft DirectX 11 Shader Model 5

Supported Graphics APIs OpenGL 4.3

DirectX 11

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API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/novell or

Notes

- 1. Quadro K2000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- 2. Quadro K2000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

NVIDIA Quadro K5000 4GB Graphics

Form Factor 4.376" H x 10.5" L

Dual Slot

Graphics Controller

Bus Type

NVIDIA Quadro K5000 Graphics Card based on the GK104 GPU

PCI Express 2.0 x16

Memory 4GB GDDR5

173GB/s memory bandwidth

Connectors

DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

No adapter included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-Link DVI adapters available as accessories

Image Quality Features

- DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support
- NVIDIA 3D Vision™ technology

Display Output

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Supported Graphics APIs OpenGL 4.2

DirectX 11 Shader model 5.0 Support

API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0, OpenCL,

Java, Python, Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

122 Watts

Note

No display output adapter included.



AMD FirePro W7000 4GB Form Factor Graphics

Full height, full length, single slot

Graphics Controller AMD FirePro™ W7000 Professional Graphics

Max Power: <150 Watts

Bus Type PCI Express™ x16, Generation 3.0

Memory 4GB GDDR5, 153.6 GB/s bandwidth, ECC support **Connectors** 4 x DisplayPort with HBR2 and MST support. DisplayPort: 4096x2160 @24bpp 60Hz **Maximum Resolution**

> Dual Link DVI: 2560x1600 (requires DP to DL-DVI adapter) Single Link DVI: 1920x1200 (requires DP to DVI adapter)

VGA: 1920x1200 (requires DP to VGA adapter)

Image Quality Features Display Output

Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component

Max number of monitors supported using DisplayPort: 6

Monitor chaining from a single DisplayPort options(subject to a max of 6 total monitors across all outputs, requires use of DisplayPort Monitors supporting MST or the use of DisplayPort hubs):

1 4096x2169 display 2 2560x1600 displays 4 1920x1200 displays

Shading Architecture

Shader Model 5.0

Supported Graphics APIs OpenGL® 4.2 with OpenGL Shading Language

OpenCL 1.1

Microsoft® DirectX® 11.1

Available Graphics Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Windows 8 (64bit and 32-bit) Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Note 1. AMD Eyefinity technology can support multiple displays using a single

enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details.

2. Factory configured FirePro W7000 graphics card does not include any video adapter cables. Adapters must be ordered separately.

3. Option Kit FirePro W7000 graphics card does not include any video cable

adapters. Adapters must be ordered seperately.

NVIDIA Ouadro K4000 3GB Graphics

Form Factor

4.376" H x 9.5" L Single Slot, Full Height

Technical Specifications - Graphics

Graphics Controller NVIDIA Quadro K4000 Graphics Card

Kepler GK106 GPU 768 CUDA cores Max Power: 80 Watts

Bus TypePCI Express 2.0 x16Memory3 GB GDDR5, 2800 Mhz192-bit memory I/O pai

192-bit memory I/O path 134 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 2 DisplayPort outputs

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

10-bit scan-out support

Display Output VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4000 DisplayPort connector at this resolution)

- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4000 DisplayPort connector: 4 with

maximum resolution of 1920 x 1200

HDMI:

- Requires use of DP-to-HDMI cable

- Max Resolution: 1920 x 1080 x 32 bpp @ 60Hz

Maximum number of monitors across all available Quadro K4000 outputs is

4.

Shading Architecture Full

Full Microsoft DirectX 11 Shader Model 5.0

Supported Graphics APIs OpenGL 4.3

OpenGL 4.3 DirectX 11

API support includes:



Available Graphics Drivers

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: tp://download.nvidia.com/novell or http://www.nvidia.com/novell or

Notes

Bus Type

- 1. Quadro K4000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- 2. Quadro K4000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. Quadro K4000 is Windows 8 Compliant.
- 4. A total maximum of 4 active monitors are supported across all display output types. To get 4 monitors, at least one monitor must be daisy chained on a DisplayPort output.
- 5. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4000 DisplayPort output.

NVIDIA Quadro K6000 12GB Graphics

Form Factor 4.376" H x 10.5" L

Dual Slot

Power: 234 Watts Weight: ~880 grams

Graphics Controller NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz PCI Express 3.0 x16

Memory 12GB GDDR5

384-bit memory I/O path 288 GB/s memory bandwidth

ECC Memory

Connectors DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-

Link DVI adapters available as accessories.

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

DisplayPort with Multi-Stream Technology (MST) and High Bit Rate

2 (HBR2), HDMI 1.4, and HDCP support

- NVIDIA 3D Vision™ technology
- **NVIDIA Premium Mosaic and nView**

Display Output

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Shading Architecture

Shader Model 5.0

Full IEEE 764-2008 32-bit and 64-bit precision

Supported Graphics APIs Full OpenGL 4.3

Full DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

1. NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro

K6000 to enable direct mapping of GPU to Virtual Machine.

2. No display output adapter included.

Technical Specifications - High Performance GPU Computing

NVIDIA Tesla C2075 Compute Processor **Form Factor** 4.376 inches by 9.75 inches

Dual Slot

System InterfacePCI Express Gen2 ×16Video OutputsOne Dual Link DVI-I

(Entry graphics level of performance)

Memory 6GB GDDR5
Peak Memory Bandwidth +170 GB/s

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit) Genuine Windows Vista Business (64-bit) Microsoft Windows XP Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: tp://download.nvidia.com/novell or http://www.nvidia.com/novell or <a href="http://www

Processor Cores 448 CUDA cores
Power Consumption ~215 Watts

NOTE 1: A 1110W PSU is required for Tesla C2075 on the Z800 **NOTE 2:** A 600W PSU is required for Tesla C2075 on the Z400 **NOTE 3:** A 1125W PSU is required for Tesla C2075 on the Z820

NVIDIA Tesla K40 Compute Processor **Form Factor** Size: 4.376 inches by 10.5 inches

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~826 grams PCI Express Gen3 ×16

Video Outputs None.

Memory 12GB GDDR5.

memory path: 384-bit memory clock: 3Ghz

Peak Memory Bandwidth 288 GB/s

Supported APIs CUDA, OpenACC, OpenCL 1.2 API support includes:

C, C++, Java, Python, and Fortran

Supported Operating

System Interface

Systems

Windows 8 (64-bit)

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

Technical Specifications - High Performance GPU Computing

ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores GK110B GPU

Base Clock: 745 MHz Boost Clock: up to 875 Mhz

2888 CUDA cores

Power Consumption ~235 Watts

Note 1: A 1125W PSU is required for any K40 configuration on the Z820

Tesla K40 GPU Boost By default the Tesla K40 active ships with the core clock set to the base

clock. HPC workloads can have one or more characteristics as described. When selecting one of the supported boost clocks a good strategy is to characterize the workload with the available boost clocks. For example, DGEMM/Linpack are extremely demanding on power. Therefore, the "base clock" may be the correct choice when running Linpack. Some workloads in life sciences, manufacturing, CFD, CAD, etc., may have power headroom

and can take advantage of one of the boost clocks.

NVIDIA Tesla K40 Compute Processor

Form Factor Size: 4.376 inches by 10.5 inches

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~826 grams

System Interface PCI Express Gen3 ×16

Video Outputs None.

Memory 12GB GDDR5,

memory path: 384-bit memory clock: 3Ghz

Peak Memory Bandwidth 288 GB/s

Supported APIs CUDA, OpenACC, OpenCL 1.2 API support includes:

C, C++, Java, Python, and Fortran

Supported Operating

Systems

Windows 8 (64-bit)

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: tp://download.nvidia.com/novell or http://www.nvidia.com/novell or <a href="http://www

Processor Cores GK110B GPU

Base Clock: 745 MHz Boost Clock: up to 875 Mhz

2888 CUDA cores

Power Consumption ~235 Watts

Note 1: A 1125W PSU is required for any K40 configuration on the Z820

Tesla K40 GPU Boost By default the Tesla K40 active ships with the core clock set to the base

clock. HPC workloads can have one or more characteristics as described. When selecting one of the supported boost clocks a good strategy is to characterize the workload with the available boost clocks. For example,

Technical Specifications - High Performance GPU Computing

DGEMM/Linpack are extremely demanding on power. Therefore, the "base clock" may be the correct choice when running Linpack. Some workloads in life sciences, manufacturing, CFD, CAD, etc., may have power headroom

and can take advantage of one of the boost clocks.

Intel Xeon Phi 3120AIB **Workstation Compute**

Processor

Form Factor Size: 247.9mm x 111.2mm

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~1400 grams

System Interface PCI Express Gen2 ×16

Video Outputs None. Memory 6GB GDDR5 Peak Memory Bandwidth 240 GB/s

Supported APIs OpenCL 1.1, x86 Multi-thread toolsets

Windows 8 (64-bit)

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores 57 cores (Many Integrated Core -MIC architecture)

Base Clock: 1.1 GHz

Turbo Boost Clock: Not Available

Power Consumption ~300 Watts

> Requires separate 8 pin and 6 pin PSU connector power source. Note 1: A 1125W PSU is required for any Intel Xeon Phi 3120AIB

configuration on the Z820

HP Slot Load DVD+/-RW Drive

Description Slim-Line. Slot-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 12.7 x 1.2 x 12.9 cm (5 x 0.5 x 5 in)

Disc Formats DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-

RW

Disc Capacity DVD-ROM 5/9/10/18 G DVD-Single / Dual (PTP, OTP) (Read

Only)

4.7G DVD±R/RW (Read & Write) DVD±R Dual (Read & Write)

80mm DVD

DVD-RAM (Read & Write)

CD-ROM 650 MB CD-ROM (Read Only)

80mm CD

800/700/650/ CD-Recordable (Read & Write) 700/650MB CD-Rewritable (Read & Write) 700/650MB High Speed CD-Rewritable (Read &

Write)

700/650MB Ultra & Ultra+ Speed CD-Rewritable

(Read & Write)

Full Stroke DVD < 270 ms (seek) **Full Stroke CD** < 250 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read DVD ROM Read CD-ROM, CD-R and CD-RW Up to 24X DVD-RAM Up to 5X

DVD Single layer Up to 8X DVD Dual Layer Up to 8X

41° to 122° F (5° to 50° C)

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC 40 mA typical, 800 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

Relative Humidity 10% to 90%

Genuine Windows 7 Professional 32-bit and 64-

Operating Systems

Supported bit. Red Hat Enterprise Linux(RHEL) WS4, 5, 6

Desktop/Workstation.

SUSE Linux Enterprise Desktop 10 & 11. Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home

32*.

No driver is required for this device. Native support is provided by the operating system.

Kit Contents Factory integrated only. Not available as a kit.

HP DVD+/-RW Drive

Description

5.25-inch, half-height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 17.5 cm (5.9 x 1.7 x 8.0 in)

Dica Formata	
Disc Formats	DVD-RAM

DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 240 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 16X DVD-ROM DL Up to 12X DVD+R Up to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC -<1000 mA typical, <1600 mA maximum

12 VDC -<1200 mA typical, <2000 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing) Relative Humidity Maximum Wet Bulb Temperature

10% to 90% 86° F (30° C)

Operating Systems

Supported

Windows 8 32-bit and 64-bit, Windows 7

Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the operating system.

Kit Contents HP SATA SuperMulti DVD Writer Drive, Roxio

Easy Media Creator software, Intervideo WinDVD Software, installation guide, and

DVD+R media.

HP DVD-ROM Drive

Description 5.25-inch, half-height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

> **CD-ROM Mode 1** < 125 ms (typical) **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek)

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental Temperature

(all conditions noncondensing)

Relative Humidity Maximum Wet Bulb Temperature

Operating Systems Supported

41° to 122° F (5° to 50° C)

10% to 90% 86° F (30° C)

Windows 7 Professional 32-bit and 64-bit. Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000. Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation.

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP Blu-Ray Writer

Description 5.25-inch, half-height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats BD-ROM

> BD-R BD-RE **DVD-RAM** DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

	Blu-ray 50 GB DL or 25 GB standard		dard
	Full Stroke DVD	< 250 ms (seek)	
	Full Stroke CD	< 210 ms (seek)	
	Blu-ray	<275 ms (seek)	
	Startup Time (Time to	BD-ROM (SL/DL)	255 / 285
	drive ready from tray loading)	BD-R (SL/DL)	255 / 285
		BD-RE (SL/DL)	255 / 285
		DVD-ROM (SL/DL)	185 / 185
		DVD-R (SL/DL)	255 / 255
		DVD-RW	25S
		DVD+R (SL/DL)	255 / 255
		DVD+RW	25S
		DVD-RAM	45S
		CD-ROM	45S
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X
Rates		CD-R	Up to 40X
	DUD DOM Dood	CD-RW	Up to 40X
	DVD ROM Read	DVD-RAM	Up to 5X
		DVD+RW	Up to 10X
		DVD-RW	Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 12X
	Plu Day	DVD-R	Up to 12X
	Blu-Ray	BD-ROM	Up to 6X
		BD-ROM DL	Up to 4.8X
		BD-R BD-R DL	Up to 6X
		BD-R	Up to 4.8X Up to 6X
		BD-RE SL/DL	Up to 4.8X
Power	Source	SATA DC power recepta	•
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p	
	De i ower Requirements	12 VDC ± 10%-100 mV ripple p-p	
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum	
	_		
Operating Environmental (all conditions non-	-	41° to 122° F (5° to 50° C)	
condensing)	Relative Humidity	15% to 80%	
condensing,	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Windows 7 Professiona Windows Vista Business Business 32*, Windows Windows 2000, Window Windows VD Home 32*	s 64*, Windows Vista Vista Home Basic 32*,

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation.

SUSE Linux Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD Software,

installation guide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc,

> digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP

support. HD-DVD movies cannot be played on this workstation.

HP DX115 Removable Drive Enclosure

Interface Type

Compatible with SAS or SATA controllers. Offers 6Gb/s performance when

used with 6Gb/s HDDs.

Dimensions (WxHxL)

Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)

HP 14-in-1 Media Card Reader

Description

Weight

Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode Supports MS-PRO 4-bit parallel transfer mode Supports MS PRO-HG Duo 4-bit parallel transfer mode

147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)

Supports SD 4-bit parallel transfer mode

Supports UHS-104 SD 4-bit card (version 3.0) Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode

Interface Type USB 3.0 High-speed interface

Note: If there is a USB2 connection, USB2 transfer speeds are supported.

Dimensions (WxHxD)

4.9 x 4 x 1 in (124.5 x 101.6 x 25.4 mm)

Supported Media Types

CompactFlash Type I

CompactFlash Type II

Microdrive

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC) SD Extended Capacity Memory Card (SDXC)

Memory Stick Memory Stick Select Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Note: These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity



Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Operating Environmental 10°C 10% R.H. ≥ 24 hours **(all conditions non-** 10°C 90% R.H. ≥ 24 hours **condensing)** 20°C 90% R.H. ≥ 24 hours

10°C 90% R.H. ≥ 24 hours 20°C 90% R.H. ≥ 24 hours 30°C 90% R.H. ≥ 24 hours 40°C 90% R.H. ≥ 24 hours 50°C 90% R.H. ≥ 24 hours 50°C 10% R.H. ≥ 24 hours

Extremes:

140°F (60°C) @ 80% R.H. for 96 hours -22°F (-30°C) @ 20% R.H. for 48 hours

No power applied
Delta °C < 1.0°C/min

Delta % R.H. < 1.5% R.H./min

Note: Test Parameters/Conditions - Power applied, unit operating on

system ±5%

Operating Systems Supported Windows 8 Pro (64-bit)*
Windows 8 (64-bit)*

Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**
Windows Vista Business 64
Windows Vista Business 32
Windows Vista Home Basic 32
Windows XP Professional
Windows XP Home 32

No driver is required for this device. Native support is provided by the

operating system.

Note: Not all features are available in all editions of Windows 8. Systems may require upgraded and/orseparately purchased hardware, drivers and/or software to take full advantage of Windows 8functionality. See

http://www.microsoft.com.

Note: Not all features are available in all editions of Windows 7. This system may require upgraded and/orseparately purchased hardware to

take full advantage of Windows 7 functionality. See

http://www.microsoft.com/windows/windows-7/ for details.

Kit Contents Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security

Software and Documentation CD

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only

Description Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode
Supports MS-PRO 4-bit parallel transfer mode

Supports MS PRO-HG Duo 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode Supports UHS-104 SD 4-bit card (version 3.0)

Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode

Interface Type USB 3.0 High-speed interface

Note: If there is a USB2 connection, USB2 transfer speeds are supported.

Dimensions (WxHxD) $4.9 \times 4 \times 1$ in (124.5 x 101.6 x 25.4 mm) Fits conveniently in the 5.25" drive

bay.

Supported Media Types CompCompactFlash Type I



HP 15-in-1 Media Card

Reader

CompactFlash Type II

Microdrive

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)

SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

Memory Stick

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Test Parameters/Conditions - Power applied, unit operating on system ±5%

Operating Systems Supported

Windows 8 Pro (64-bit)*
Windows 8.1 (64-bit)*

Windows 8 (64-bit)*

Windows 7 Professional (32-bit)**

Windows 7 Professional (64-bit)**

Windows Vista Business 64

Windows Vista Business 32

Windows Vista Home Basic 32

Windows XP Professional

Windows XP Home 32

No driver is required for this device. Native support is provided by the

operating system.

Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or

software to take full advantage of Windows 8 functionality. See

http://www.microsoft.com.

Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full

advantage of Windows 7 functionality. See

http://www.microsoft.com/windows/windows-7/ for details.

Kit Contents Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security

Software and Documentation CD

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design

Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCIe Card

Data Transfer Rate Supports up to 800 Mbps **Devices Supported** IEEE-1394 compliant devices **Bus Type** PCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin connectors (Rear)

Internal Connectors One 10-Pin Header connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-

ROM drive, built in sound system, Available PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C) Temperature – Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and

HP Thunderbolt-2 PCIe 1- Data Transfer Rate port I/O Card

Devices Supported

Supports up to 20 Gb/s (20,000 Mb/s) Thunderbolt™ certified devices

Bus Type PCIe card, full or half height PCIe slots

One Thunderbolt™ 2 external 20-Pin output connectors (Rear) **Ports**

Internal Connectors One 5-Pin header connector

System Requirements Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel

i5 series or higher processor, 128-MB RAM, 1-GB Hard Drive, available PCIe

slot.

Temperature - Operating 50° to 131° F (10° to 55° C)

-22° to 140° F (-30° to 60° C) Temperature - Storage

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD.

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported **Kit Contents** Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.

HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height

bracket, DisplayPort to DisplayPort cable, internal header cables(2), user

documentation and warranty card.

Warranty The HP Thunderbolt™ 2 PCIe 1-port I/O Card has a one-year Limited

> Warranty or the remainder of the warranty of the HP supported product in which it is installed. Technical support is available seven days a week, 24

hours a day, by phone, as well as online support forums. Certain

restrictions and exclusions apply.

Technical Specifications - Networking and Communications

Integrated Intel 82579LM Connector RJ-45

PCIe GbE Controller

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus ArchitecturePCI Express and SMBusData Path WidthSingle Channel PCI-Express

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus for

host and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic. AMT 7.0 support

Intel Gigabit CT Desktop NIC

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power Requirement

Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C) **Operating Humidity** 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise

Desktop (SLED) 11

Technical Specifications - Networking and Communications

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents

Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

Broadcom (5761) **NetXtreme Gigabit Ethernet Plus NIC**

Connector **RJ-45**

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash 10/100/1000 Mbps **Data Rates Supported**

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

> 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity

131° F (55° C) with 5% to 95% non-condensing humidity **Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64

Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0,

DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install

guide, product warranty statement

HP X520 10GbE Dual Port Hardware Certifications

Adapter

FCC B, UL, CE, VCCI, BSMI, CTICK, KCC

HP 10GbE SFP+ SR Transceiver

Operating Temperature Operating Humidity

0°C to 45°C (32°F to 113°F) 0% to 85%, noncondensing 0.47(h) x 0.54(w) x 2.19(d)inches

Dimensions $(H \times W \times D)$

(1.19 x 1.38 x 5.57 cm)

HP 361T PCIe Dual Port Connector

Gigabit NIC Controller

Intel® Ethernet I350 Controller



Two RJ-45

Technical Specifications - Networking and Communications

Data Rates Supported 10/100/1000 Mbps, Half- and full-duplex

Compliance 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az, IEEE

1588

PCIe v2.0 standard RoHS (6 of 6)

FCC (U.S. only) Class B DOC (Canada) Class B

CE EN 55024, EN55022 Class B

VCCI Class II **UL 1950** CSA 950 EN 60950 CE ACPI 1.1a

Microsoft WHQL (Windows Hardware Quality Labs)

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express

slots

Power Requirement 4.1W idle without EEE link partner

3.2W idle with EEE link partner

4.2W maximum

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

> 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature 32° to 131°F (0° to 55° C) **Operating Humidity** 10% to 95% non-condensing

Dimensions $(H \times W \times D)$ 5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)

Support

Operating System Driver Windows 7 Professional 32-bit and 64-bit.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management Capabilities WOL, PXE 2.1

Kit Contents HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket

attached to it (the low profile bracket is included in the clamshell that the

PCA ships in)

Product Warranty statement and the Quick Install Card (QIC).

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Summary of Changes

Date of change:	Version History:		Description of change:
June 24	From v40 to v41	Changed	Updated SATA Solid State Drives and added notes to two graphic card
			listings in the Supported Components section.
		Added	Secondary IdNumber
lulu 1	From v41 to v42	Changed	Updated the processor table and added the Intel Xeon Phi 3120AIB
July 1			Compute Processor in High Performance GPU computing.
July 22	From v42 to v43	Added	Graphics: nVIDIA Quadro Sync, Intel Phi P3120. SSD Drives: 256GB 2.5" SED
			SSD SATA and 1 TB SSD 2.5" SATA and 2.5" adapter. Networking: WLAN
			Intel 7260 802.11. Memory: 32GB DDR3-1866 ECC LR RAM
September 4, 2014	From v43 to v44		Updated statement and note for K6000 card support.
November 1, 2014	From v44 to v45	Changed	Interna USB statement from Overview, System board Memory configuration
			Note, Low Halogen statement.
		Added	HP 256GB SATA 6Gb/s SED Opal 2 SSD.
		Removed	Windows 7 Home/Premium, Windows 7 Ultimate 64-bit*, DDR3-1600 ECC
			Registered DIMMs and
			32GB DDR3-1333 ECC (LR) RAM, Intel Gigabit CT Desktop NIC,

